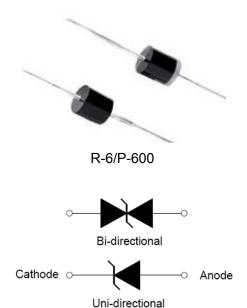
JIEJIE MICROELECTRONICS CO., Ltd

JRB Series 6000W TVS

Rev.2.2

DESCRIPTION

The JRB series of high current uni/bi-directional transient suppressors are designed for A.C. line protection and high power DC bus clamping applications. These devices offer uni/bi-directional port protection from 20 volts to 43 volts. They provide a clamping voltage lower than the avalanche voltage. Therefore, any voltage rise due to increased current conduction is contained to a minimum, providing the best possible protection level. They can also be connected in series and/or parallel to create very high capacity protection solutions.



Symbol

FEATURES

- Low incremental surge resistance.
- ♦ Excellent clamping capability.
- → JEDEC R-6/P-600 molded plastic.
- Color band denoted cathode except bidirectional.
- ♦ High temperature wave soldering: 265°C/10s at terminals.
- ♦ Plastic package has under writers laboratory flammability 94V-0.
- ♦ 6000W peak pulse power capability at 10×1000µs waveform.
- ♦ Fast response time: typically less than 1.0ps from 0V to V_{BR} min.

ABSOLUTE MAXIMUM RATINGS(T_A=25°C, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak pulse power dissipation on 10/1000µs waveform	P _{PP}	6000	W
Peak pulse current on 10/1000µs waveform	I _{PP}	See next table	Α
Steady state power dissipation at T _L =75℃	P _{M(AV)}	8	W
Operating junction and storage temperature range	T _{J,} T _{STG}	-55 to +175	$^{\circ}$ C
Peak forward surge current, 8.3ms single half sine-wave	I _{FSM}	400	Α
Typical thermal resistance junction to lead	$R_{ heta JL}$	8.0	°C/W
Typical thermal resistance junction to ambient	R _{θJA}	40	°C/W



ELECTRICAL CHARACTERISTICS(T_A=25°C)

Part N	Number	V_R	I _R @V _R	V_{BR}	@I _T	I _T	V _C @I _{PP}	l _{PP} ^①
Uni-Polar	Bi-Polar	V	μA	min(V)	max(V)	mA	max(V)	Α
JRB20A	JRB20CA	20	5	22.2	24.5	5	32.4	185.2
JRB22A	JRB22CA	22	5	24.4	26.9	5	35.5	169.0
JRB24A	JRB24CA	24	5	26.7	29.5	5	38.9	154.2
JRB26A	JRB26CA	26	5	28.9	31.9	5	42.1	142.5
JRB28A	JRB28CA	28	5	31.1	34.4	5	45.4	132.2
JRB30A	JRB30CA	30	5	33.3	36.8	5	48.4	124.0
JRB33A	JRB33CA	33	5	36.7	40.6	5	53.3	112.6
JRB36A	JRB36CA	36	5	40.0	44.2	5	58.1	103.3
JRB40A	JRB40CA	40	5	44.4	49.1	5	64.5	93.0
JRB43A	JRB43CA	43	5	47.8	52.8	5	69.4	86.5

① Surge waveform:10/1000µs

V_R: Stand-off voltage -- Maximum voltage that can be applied

V_{BR}: Breakdown voltage

 V_{C} : Clamping voltage -- Peak voltage measured across the suppressor at a specified I_{PP}

I_R: Reverse leakage current

RATINGS AND V-I CHARACTERISTICS CURVES (T_A =25 $^{\circ}$ C, unless otherwise noted)

FIG.1:V- I curve characteristics (Uni-directional)

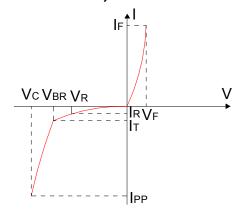


FIG.2:V- I curve characteristics (Bi-directional)

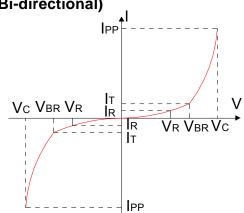


FIG.3: Pulse waveform

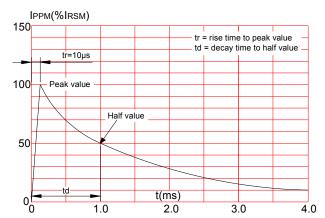
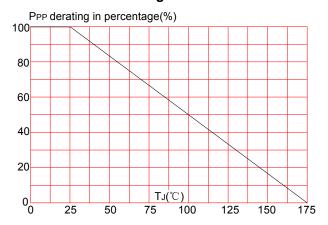
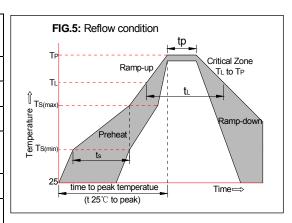


FIG.4: Pulse derating curve



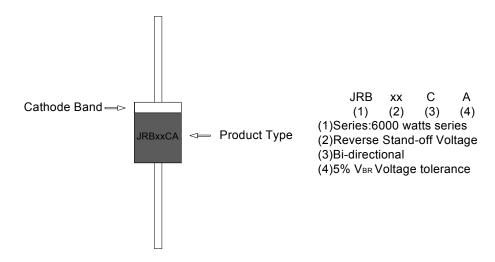
SOLDERING PARAMETERS

Reflow Co	ondition	Pb-Free assembly (see FIG.5)	
	-Temperature Min (T _{s(min)})	+150℃	
Pre Heat	-Temperature Max(T _{s(max)})	+200℃	
	-Time (Min to Max) (t _s)	60-180 secs.	
Average (T _L)to pe	ramp up rate (Liquidus Temp eak)	3℃/sec. Max	
T _{s(max)} to	T _L - Ramp-up Rate	3°C/sec. Max	
Doflow	-Temperature(T _L)(Liquidus)	+217℃	
Reflow	-Temperature(t _L)	60-150 secs.	
Peak Tem	np (T _p)	+260(+0/-5)°C	
Time with	in 5°Cof actual Peak Temp (t _p)	20-40secs.	
Ramp-do	wn Rate	6°C/sec. Max	
Time 25°	to Peak Temp (T _P)	8 min. Max	
Do not ex	ceed	+260℃	

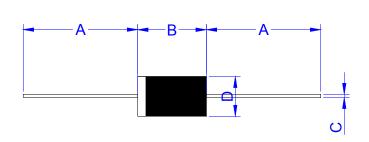


Flow/Wave Soldering(Solder Dipping)				
Peak temperature	265 ℃			
Dipping time	10 sec.			
Soldering	1 time			

MARKING & ORDERING INFORMATION



PACKAGE MECHANICAL DATA



	Dimensions			
Ref.	Inches		Millimeters	
	Min.	Max.	Min.	Max.
Α	1.000	_	25.40	-
В	0.339	0.370	8.60	9.40
С	0.047	0.055	1.20	1.40
D	0.339	0.358	8.60	9.10

Part Number	UNIT WEIGHT (g/PCS) typ.	Case Type	Quantity	Packing Option
JRBxxA/CA	2.4	R-6/P-600	300	Вох

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